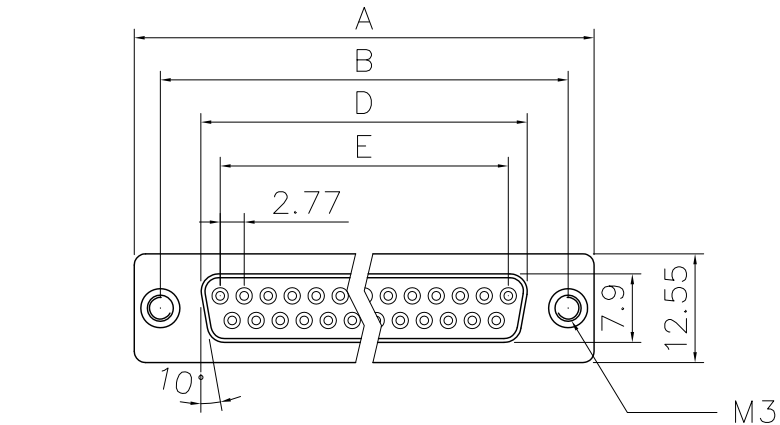
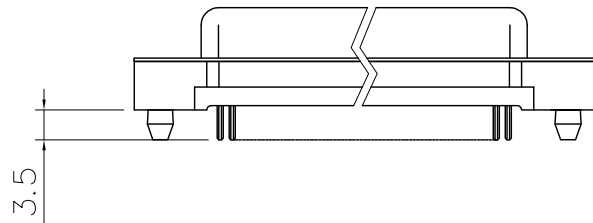
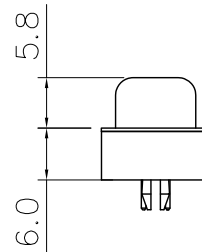
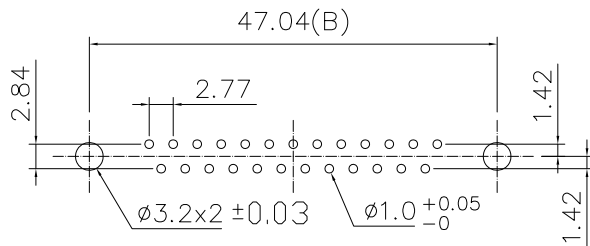


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Customer drawing



Dimensions

Positions	A	B	D	E
9	30.81	24.99	16.33	11.08
15	39.20	33.30	24.70	19.39
25	53.05	47.04	38.40	33.24
37	69.40	63.50	54.80	49.86

REVISIONS

SYM	ECN	DESCRIPTION	DATE	APPROVED
1	HK--	First Release Drawing	10/20/08	IP
2	HK--	Update the Drawing	03/06/14	IP

D-SUB TECHNICAL DATA

SHELL:	Steel, 100u" Tin Over 50u" min nickel over 50u" min Copper
BODY:	Glass-Filled Thermoplastic PA9T,UL94V-0 rated
CONTACTS:	Copper alloy, Gold flash over 50u" min nickel on contact area. 100u" min tin over 50u" min nickel on solder area.
BOARDLOCK:	Brass, 80u" min Nickel Plated
ELECTRICAL:	Contact Resistance :20 Milliohms Max Insulation Resistance : 1000 megohms Dielectric Withstanding Voltage : 1000 VAC/rms Current Rating : 3AMP Voltage Rating:250 VAC/rms 60Hz
MARKING:	Amphenol...(Series No.) Commercial reference Manufacturing date

PRODUCT CODE

L 77 TS X G XX S OL2 RM5

L: RoHS Compliance

Tinned shell for receptable

Shell Size: E,A,B,C

Mounting Options:
G=M3

Board mounting options
RM5=Retention Clip

Termination:
OL2 :L=6.02mm

Contact Type:
S=Socket

Configuration:
09,15,25,37

UNLESS OTHERWISE SPECIFIED TOLERANCES		APPROVAL		DATE
	U.S.			
	METRIC	DRAWN	Mary Ma	03/06/14
.X +/-	0.50	CHECKED	Tony Tang	03/06/14
.XX +/-	0.30	CHECKED		
.XXX +/-	0.20			
FRACTIONS +/-				
ANGLES +/-	5°			
FOR MATERIALS AND FINISHES SEE NOTES		DRAWING FILE :		
REMOVE SHARP EDGES		ANGLE OF PROJECTION		
DIMENSIONS				
U.S.	INCHES			
METRIC	MM			

Amphenol

Amphenol East Asia Limited

TITLE

D-SUB connectors, TS series

SIZE	DRAWING NO.	REV.
A4	C L77TSXGX SOL2RM5	2
SCALE	NONE	SHEET 1 OF 1